Description

The AL5890 is a 400V constant current LED driver and it provides a cost-effective two pin solution. It has good temperature stability and the current accuracy of < ±2.0mA (typ.) regulated over a wide voltage and temperature range. The AL5890 comes in various or pre-fixed output current options removing the need for external current setting resistors and creating a simple driver solution for the series of LEDs. The AL5890 supports both the high-side and low-side driving of LED chains.

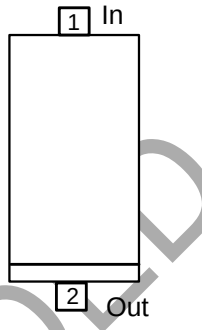
The AL5890 turns on when the voltage between IN and OUT is greater than 7V. Long LED chain application up to 400V operating voltage subject to package thermal limitation.

The AL5890 is available in thermally robust PowerDI®123 (Type B), SOT89 and TO252 (Standard) packages.

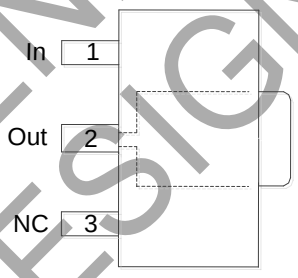
Features

- DC up to 400V Operating Voltage With Long LED Chains Subject to Package Thermal Constraint
- LED Current Tolerance Over Wide Temperature Range < ±2.0mA (typ.)
- Thermal Foldback Protection
- 10mA, 15mA, 20mA, 30mA, and 40mA pre-fixed Constant Output Current Options
- PowerDI123 (Type B), SOT89 and TO252 (Standard) Thermally Enhanced Packages
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

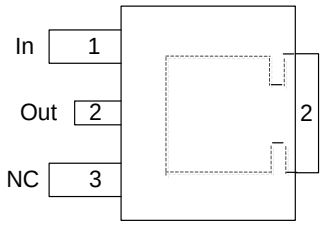
Pin Assignments (Top View)



PowerDI123 (Type B)



SOT89



TO252 (Standard)

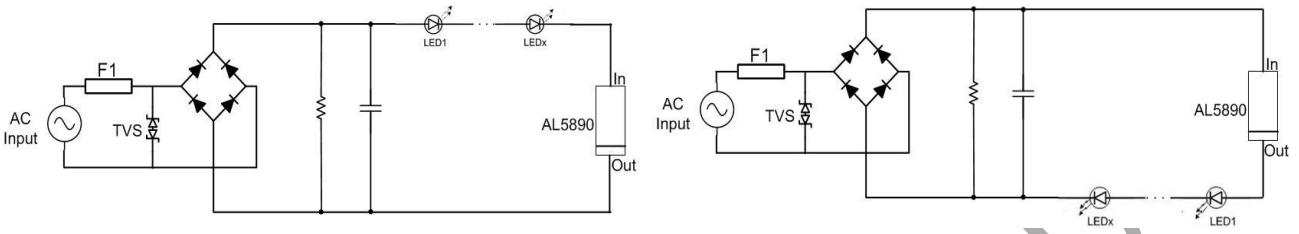
Applications

- Commercial LED Lighting Fixtures
- Emergency Lighting
- Signage, Downlights, Decorative and Architectural Lighting

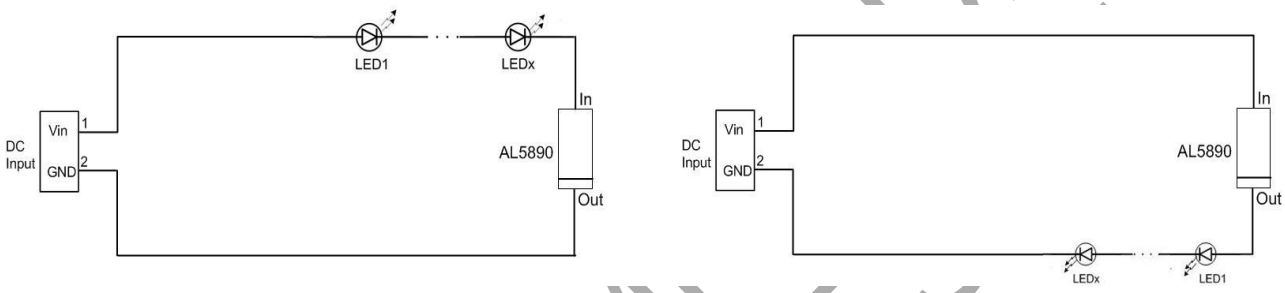
Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit

(AC Configuration)



(DC Configuration)

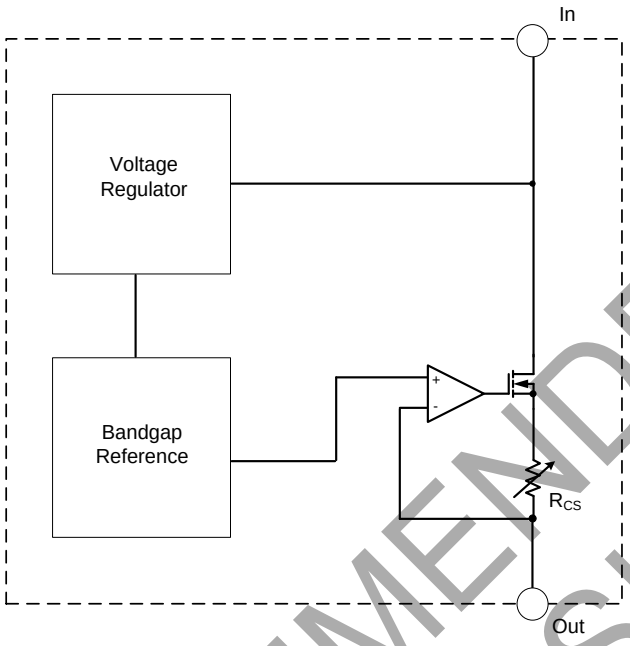


Pin Descriptions

Pin Name	Pin Number			Function
	PowerDI123 (Type B)	SOT89	TO252 (Standard)	
In	1	1	1	LED Current Input Terminal (Note 4)
Out	2	2	2	LED Current Output Terminal (Note 4)
NC	-	3	3	Not Connected
Exposed Pad	-	2	2	-

Note: 4. Stresses greater than the Absolute Maximum Ratings specified above may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time. Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

Functional Block Diagram



Absolute Maximum Ratings (Note 4)

Symbol	Parameters	Ratings	Unit
V_{IN_OUT}	IN Voltage Relative to OUT Pin	-0.3 to +425	V
I_{IN_OUT}	LED Current Flows from IN to OUT Pin	50	mA
T_J	Operating Junction Temperature	-40 to +150	°C
T_{ST}	Storage Temperature	-55 to +150	°C

ESD Ratings

Symbol	Parameter	Rating	Unit
V_{ESD}	Human-Body Model (HBM)	2000	V
	Charged-Device Model (CDM)	1000	

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{IN_OUT}	IN Voltage Relative to OUT Pin	7	400	V
I_{IN_OUT}	Current Flows from IN to OUT Pin	10	40	mA
T_A	Operating Ambient Temperature Range	-40	+105	°C
T_J	Operating Junction Temperature	-40	+125	°C

Thermal Information (Note 5)

Package	θ_{JC} Thermal Resistance Junction-to-Case	θ_{JA} Thermal Resistance Junction-to-Ambient	P_{DIS} T_A = +25°C, T_J = +125°C
PowerDI123 (Type B)	15.33°C/W	75.84°C/W (Note 6)	1.33W
SOT89	6.34°C/W	27.85°C/W (Note 6)	3.61W
TO252 (Standard)	5.10°C/W	26.12°C/W (Note 6)	3.85W

Note: 5. When mounted on 50.8mm x 50.8mm GETEK PCB with 25.4mm x 25.4mm 2oz copper pads. For better thermal performance, larger copper pad for heat-sink is needed.

6. Stresses greater than the Absolute Maximum Ratings specified above may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time. Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

Electrical Characteristics (V_{IN_OUT} = 10V, T_A = +25°C, T_J < +125 °C, Unless Otherwise Noted.)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
V_{IN_OUT}	Supply Voltage	(Note 7)	7	-	400	V
V_{MIN}	Minimum Power Up Voltage	Increase V_{IN_OUT} (Note 8)	2.5	5	7	V
I_{IN_OUT}	LED Current (Note 9)	AL5890-10	9.0	10	11.0	mA
		AL5890-15	13.5	15	16.5	
		AL5890-20	18.5	20	21.5	
		AL5890-30	28.0	30	32.0	
		AL5890-40	38.0	40	42.0	
I_{LINE}	Line Regulation	V_{IN_OUT} = 20V to 60V, 20mA current option	-	1.5	-	%
T_{coeff}	Temperature Coefficient	(Note 10)	-	3	-	%
t_{ON}	Turn On Delay Time	-	-	6	-	µs
t_{OFF}	Turn Off Delay Time	-	-	0.3	-	µs
t_R	Rising Time	-	-	6	-	µs
t_F	Falling Time	-	-	0.1	-	µs
T_{FOLD}	Thermal Foldback Junction Temperature	Junction Temperature	-	+130	-	°C

Note: 7. DC power supply slew rate set at 10V/msec to avoid any excessive inrush current.

8. Apply the power supply voltage linearly to the chip until the device starts to turn on (output LED current reaches 5% of the desired current options). The minimum power up voltage may vary with different current options.

9. Based on ATE trimmed accuracy at +25°C.

10. This parameter only guaranteed by design, not tested in production.

Typical Performance Characteristics (PowerDI123 (Type B), 20mA Device) – 1"x1" PCB with 2oz. Copper, no Heatsink

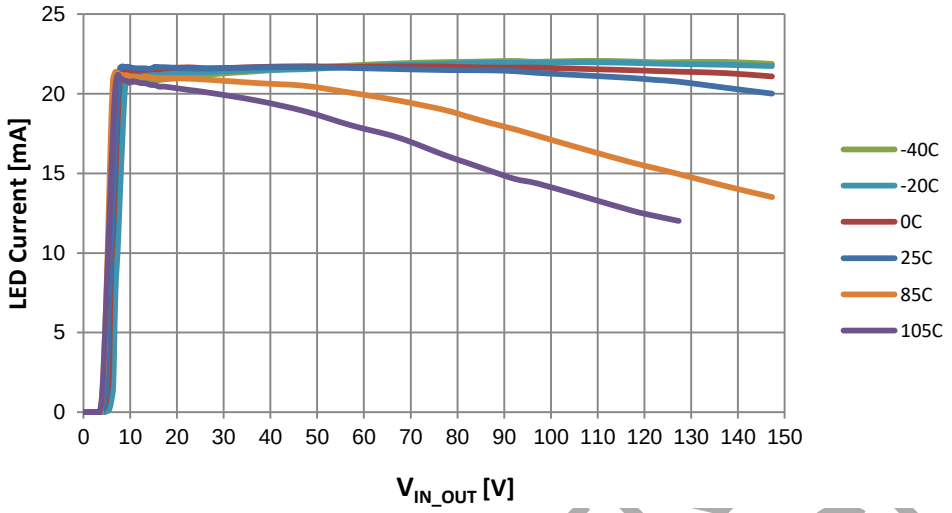


Figure 1. LED Current (-40°C to 105°C) vs. V_{IN_OUT}

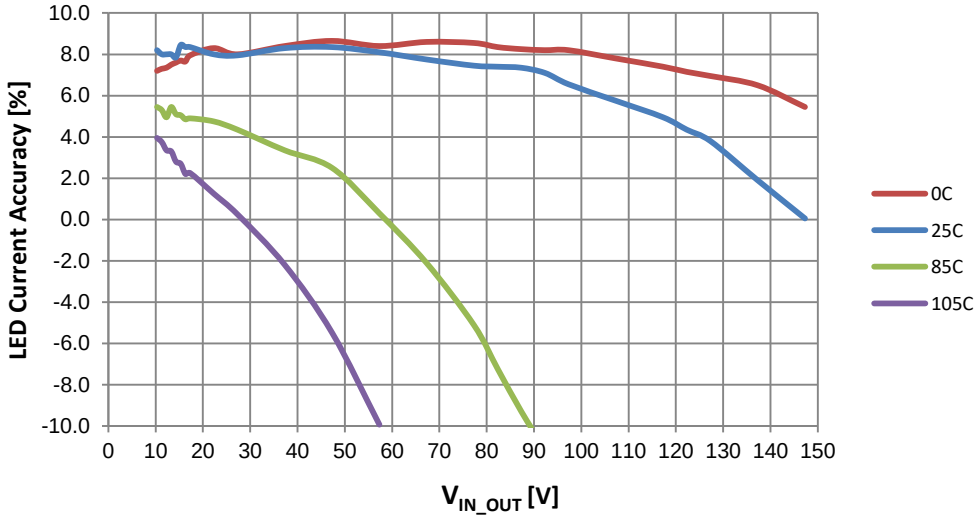


Figure 2. LED Current Accuracy (0°C to 105°C) vs. V_{IN_OUT}

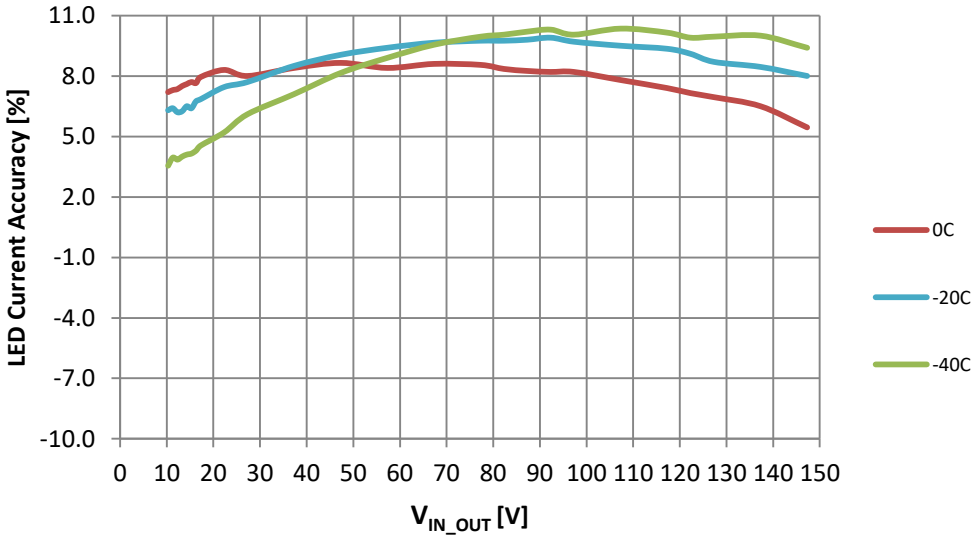


Figure 3. LED Current Accuracy (-40°C to 0°C) vs. V_{IN_OUT}

Typical Performance Characteristics (Cont.) (PowerDI123 (Type B), 20mA Device) – 1"x1" PCB with 2oz. Copper, no Heatsink

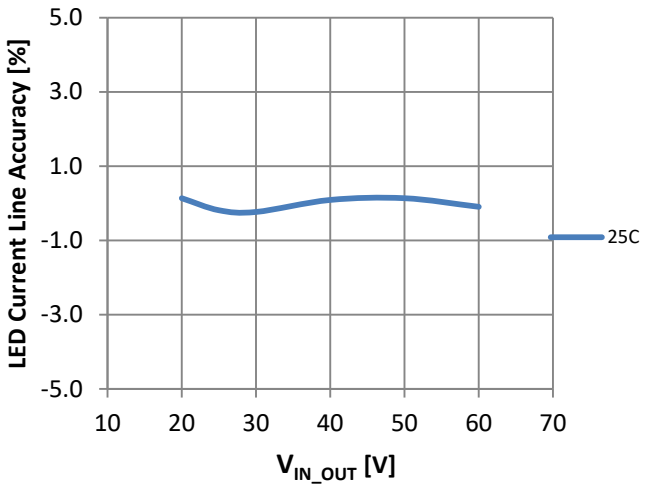


Figure 4. LED Line Regulation @ 25°C vs. V_{IN_OUT} (20V to 60V)

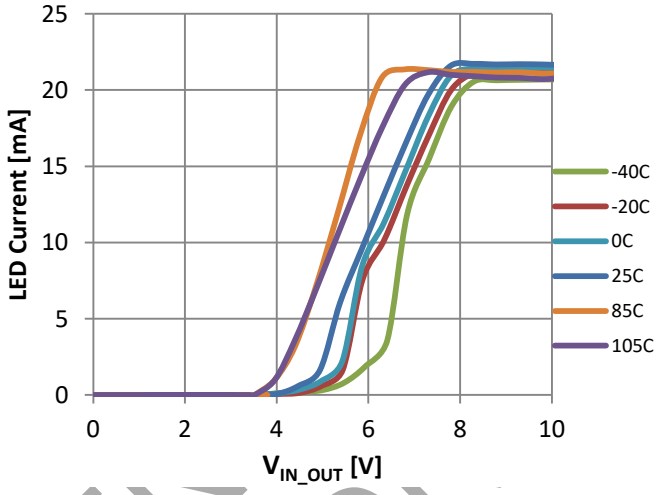


Figure 5. Startup Minimum Operating Voltage

Typical Performance Characteristics (40mA SOT89-3 Options) – 1"x1" PCB with 2oz. Copper, no Heatsink

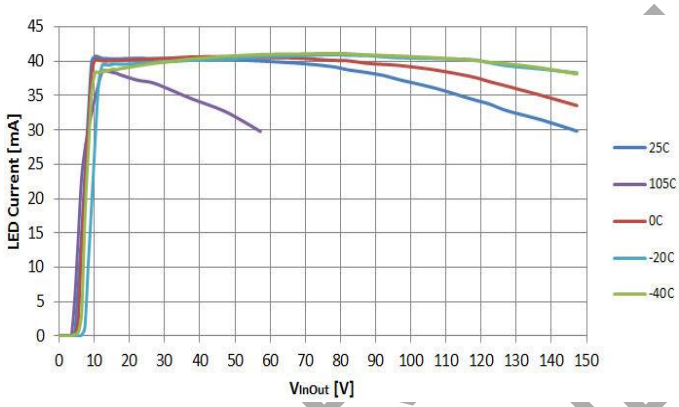


Figure 6. LED Current (-40°C to +105°C) vs. V_{IN_OUT}

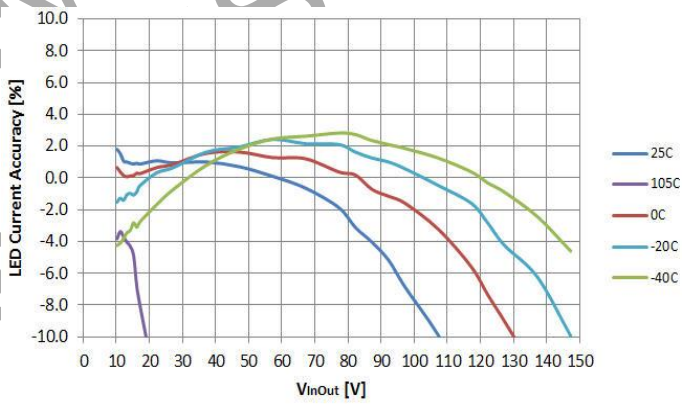


Figure 7. LED Current Accuracy (-40°C to +105°C) vs. V_{IN_OUT}

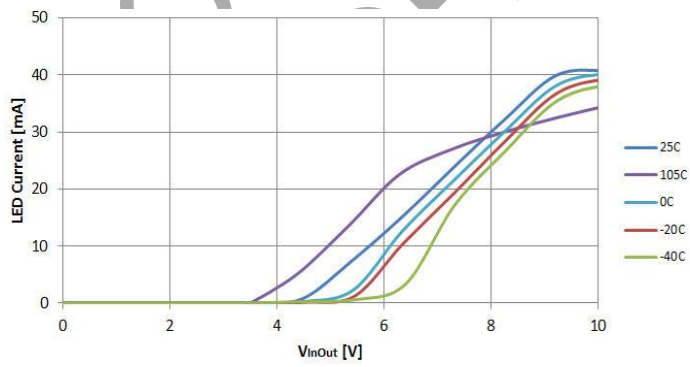


Figure 8. Device Turning On Threshold Across Temperature

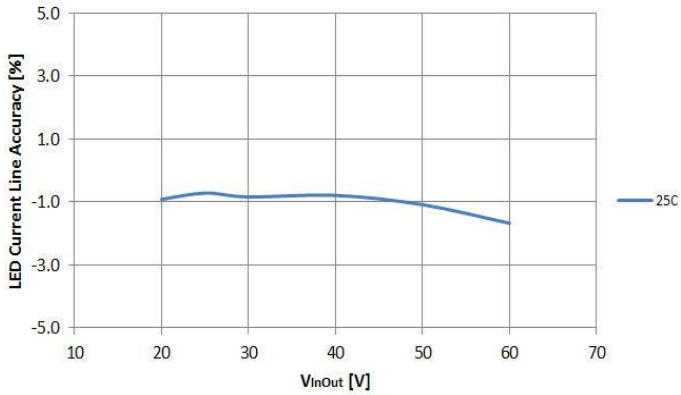


Figure 9. LED Line Regulation (% @ +25°C) vs. V_{IN_OUT} (20V to 60V)

Typical Performance Characteristics (40mA TO252 (Standard)-3 Options) – 1"x1" PCB with 2oz. Copper, no Heatsink

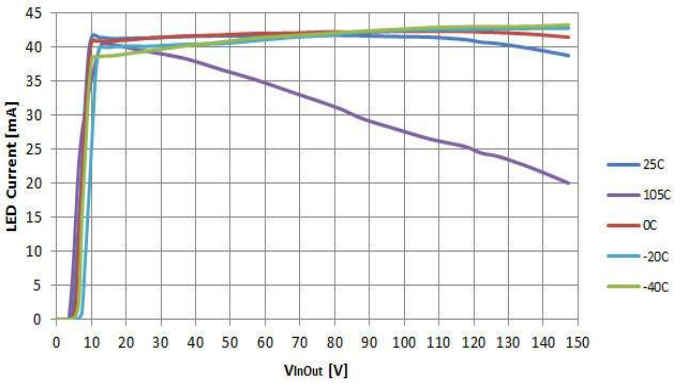


Figure 10. LED Current (-40°C to +105°C) vs. V_{IN_OUT}

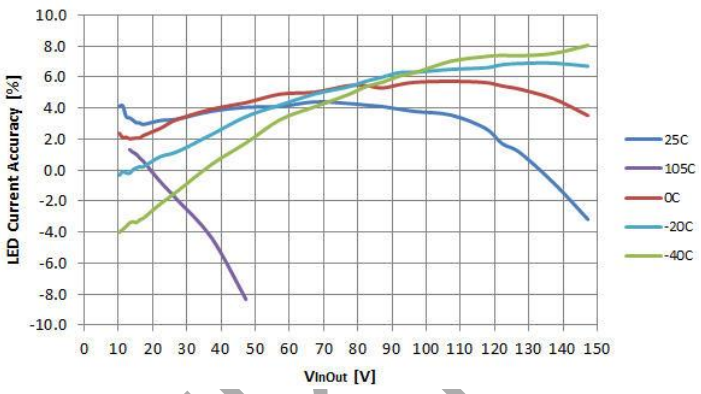


Figure 11. LED Current Accuracy (-40°C to +105°C) vs. V_{IN_OUT}

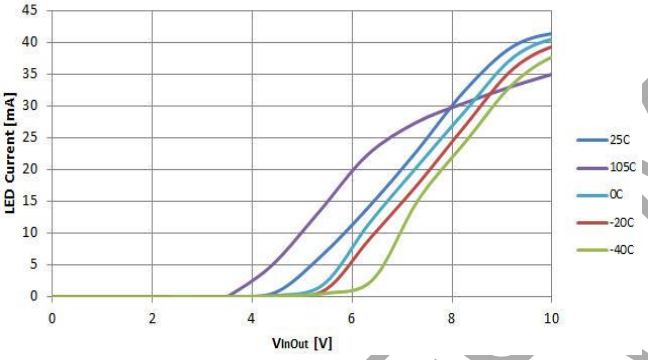


Figure 12. Device Turning On Threshold Across Temperature

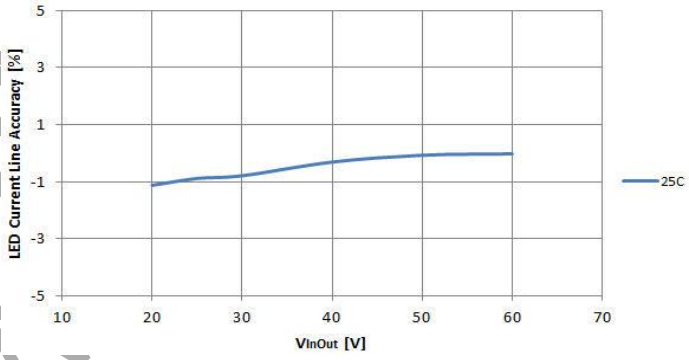


Figure 13. LED Line Regulation (% @ +25°C) vs. V_{IN_OUT} (20V to 60V)

Application Information

Description

The AL5890 is a constant current Linear LED driver and can be connected in series with LEDs as a High Side or a Low Side constant current regulator. The AL5890 offers various current settings from 10mA to 40mA and different current settings available upon request.

Simple LED String (AC/DC Configuration)

The AL5890 can be connected in series with LEDs as a Low Side or High Side constant current regulator. The number of the LEDs can vary from one to as many as supported by the input supply voltage. The designer needs to calculate the maximum voltage between IN pin and OUT pin by taking the maximum input voltage less the voltage across the LED string.

(AC Configuration)

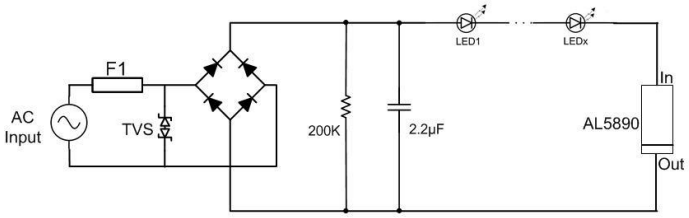


Figure 14. Low Side AC Application

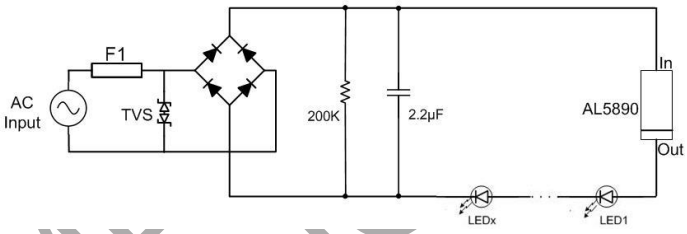


Figure 15. High Side AC Application

The AL5890 can also be used at the high side of the IC, see Figure 7. The minimum system input voltage can be calculated by:

$V_{IN(MIN)} = V_{LED\_CHAIN} + 7V$, Where V_{LED_CHAIN} is the LED chain voltage.

(DC Configuration)

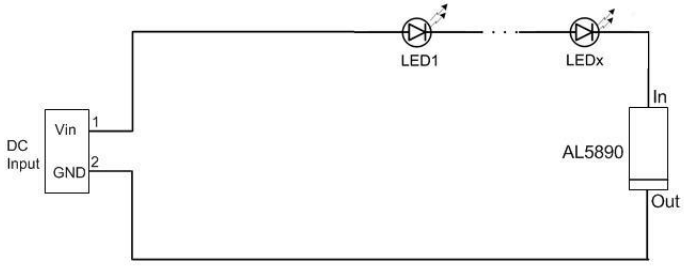


Figure 16. Low Side DC Application

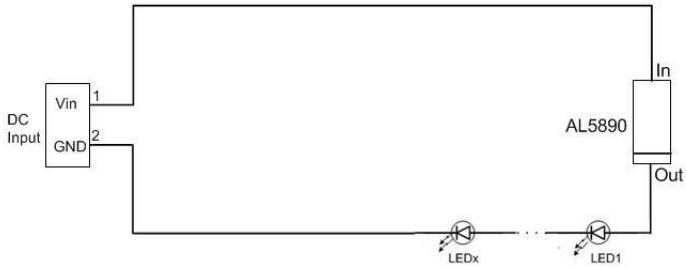
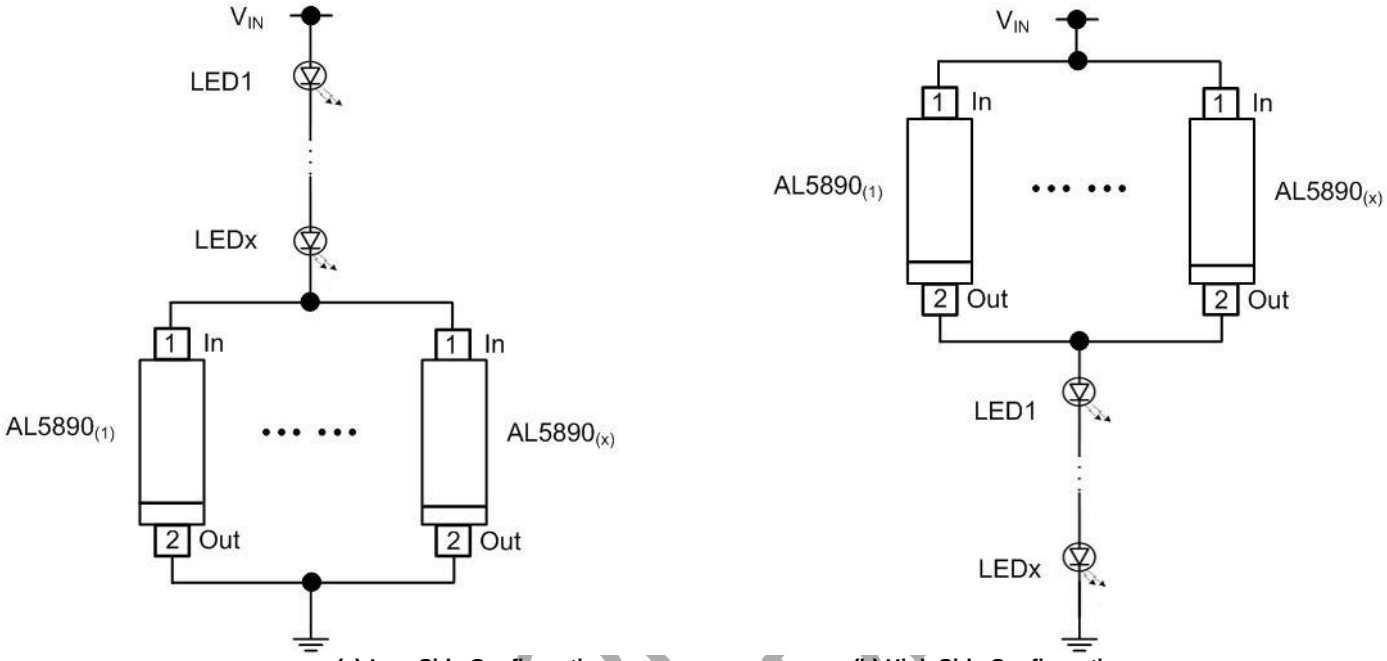


Figure 17. High Side DC Application

Application Information (Cont.)

Higher Current Requirement in Parallel Configuration

The LED current can be increased by connecting two or more AL5890 in parallel as Figure 10.



(a) Low Side Configuration **(b) High Side Configuration**

Figure 18. Parallel Configuration of AL5890

Application Information (Cont.)

Thermal Fold-back Protection (TFP)

The AL5890 has a thermal fold-back protection (TFP) function and adopts self-adaptive control method, which can prevent the system from breaking down caused by high temperature. The typical overheating temperature is set at +130°C, when the junction temperature of the IC is higher than +130°C, the device will linearly decrease the internal reference voltage to decrease the output current. As a result of this feature, the device can control the system's output power at high ambient temperature, to control the quantity of heat of the system. This enhances the safety of the system at high temperature.

Thermal fold-back waveform AL5890-10mA (PowerDI123 (Type B) package, 1"x1" PCB with 2oz copper, no heatsink) with V_{IN_OUT} = 100V is shown as below:

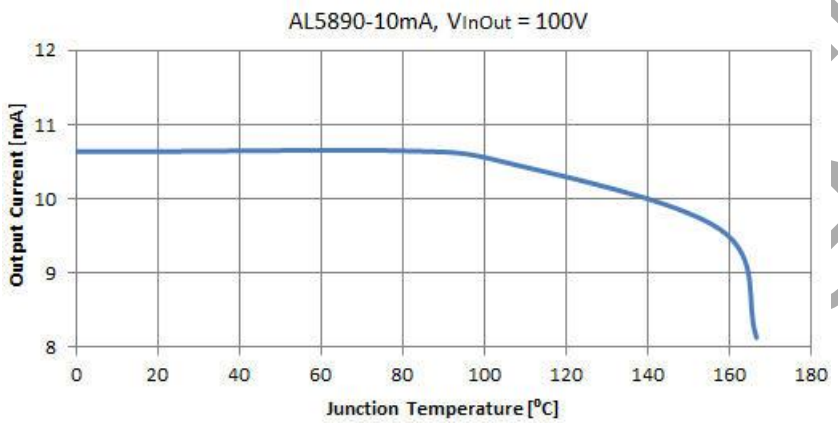


Figure 19. Thermal Foldback Characteristic

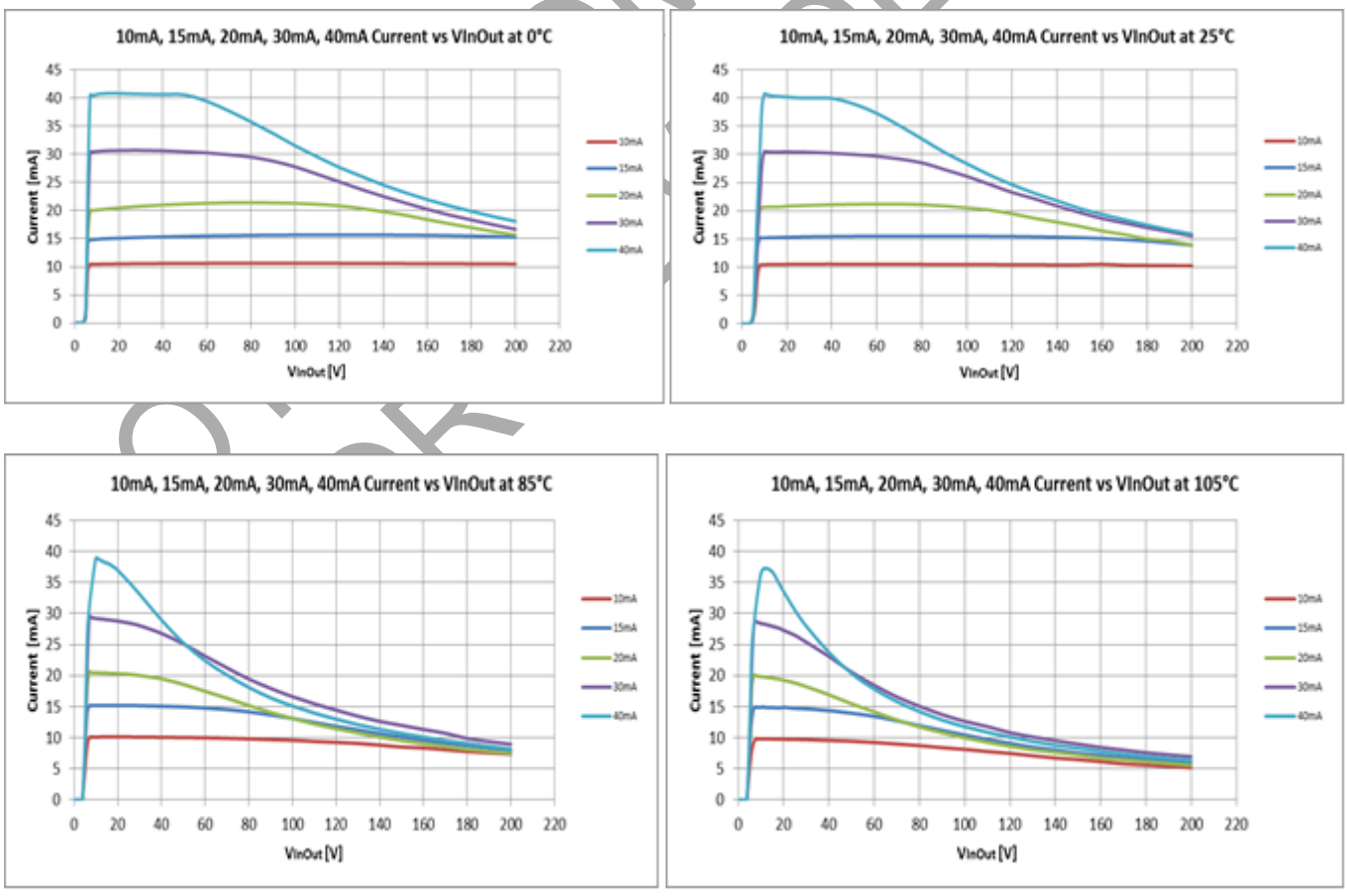
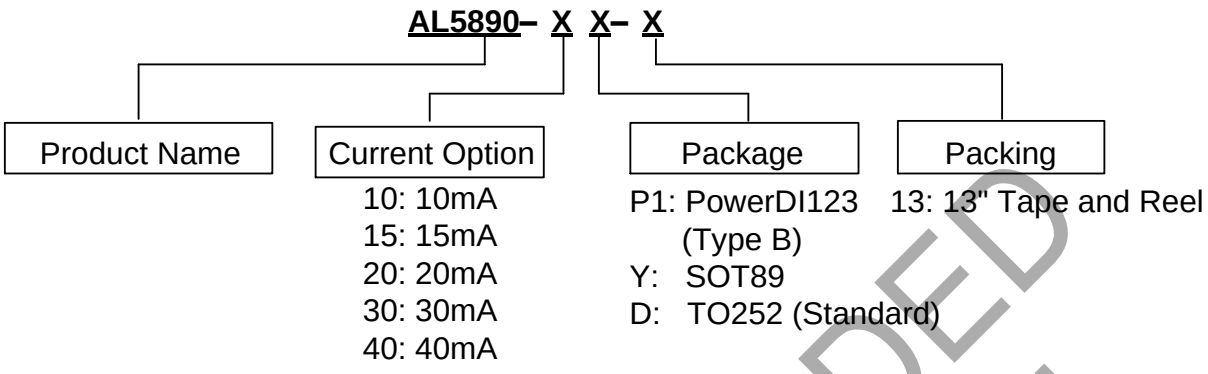


Figure 20. Thermal Foldback Characteristic with Different Current Option across Temperature

Ordering Information

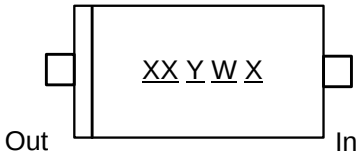


Part Number	LED Current Option	Package Code	Packaging	13" Tape and Reel	
				Quantity	Part Number Suffix
AL5890-10P1-13	10mA	P1	PowerDI123 (Type B)	10,000/ Tape & Reel	-13
AL5890-15P1-13	15mA	P1	PowerDI123 (Type B)	10,000/ Tape & Reel	-13
AL5890-20P1-13	20mA	P1	PowerDI123 (Type B)	10,000/ Tape & Reel	-13
AL5890-30P1-13	30mA	P1	PowerDI123 (Type B)	10,000/ Tape & Reel	-13
AL5890-40P1-13	40mA	P1	PowerDI123 (Type B)	10,000/ Tape & Reel	-13
AL5890-10Y-13	10mA	Y	SOT89	2,500/ Tape & Reel	-13
AL5890-15Y-13	15mA	Y	SOT89	2,500/ Tape & Reel	-13
AL5890-20Y-13	20mA	Y	SOT89	2,500/ Tape & Reel	-13
AL5890-30Y-13	30mA	Y	SOT89	2,500/ Tape & Reel	-13
AL5890-40Y-13	40mA	Y	SOT89	2,500/ Tape & Reel	-13
AL5890-10D-13	10mA	D	TO252 (Standard)	2,500/ Tape & Reel	-13
AL5890-15D-13	15mA	D	TO252 (Standard)	2,500/ Tape & Reel	-13
AL5890-20D-13	20mA	D	TO252 (Standard)	2,500/ Tape & Reel	-13
AL5890-30D-13	30mA	D	TO252 (Standard)	2,500/ Tape & Reel	-13
AL5890-40D-13	40mA	D	TO252 (Standard)	2,500/ Tape & Reel	-13

Marking Information

(1) PowerDI123 (Type B)

(Top View)

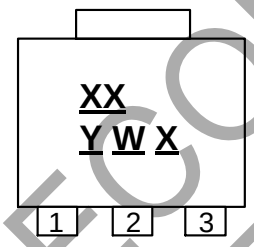


XX : Identification code
Y : Year 0 to 9
W : Week : A to Z : 1 to 26 week;
a to z : 27 to 52 week; z represents 52 and 53 week
X : Internal code

Part Number	Package	Identification Code
AL5890-10P1-13	PowerDI123 (Type B)	B2
AL5890-15P1-13	PowerDI123 (Type B)	B3
AL5890-20P1-13	PowerDI123 (Type B)	B4
AL5890-30P1-13	PowerDI123 (Type B)	B5
AL5890-40P1-13	PowerDI123 (Type B)	B6

(2) SOT89

(Top View)

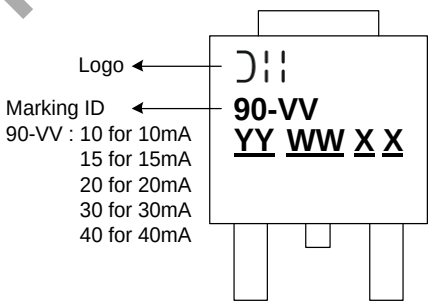


XX : Identification code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week;
z represents 52 and 53 week
X : Internal code

Part Number	Package	Identification Code
AL5890-10Y-13	SOT89	B2
AL5890-15Y-13	SOT89	B3
AL5890-20Y-13	SOT89	B4
AL5890-30Y-13	SOT89	B5
AL5890-40Y-13	SOT89	B6

(3) TO252 (Standard)

(Top View)



YY : Year : 01 to 09
WW : Week : 01 to 52, 52 represents 52 and 53 week
XX : Internal Code

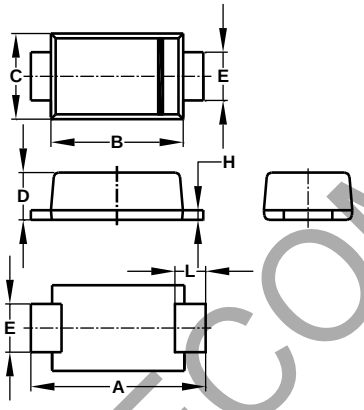
Marking Information(Cont.)

Part Number	Package	Identification Code
AL5890-10D-13	TO252 (Standard)	B2
AL5890-15D-13	TO252 (Standard)	B3
AL5890-20D-13	TO252 (Standard)	B4
AL5890-30D-13	TO252 (Standard)	B5
AL5890-40D-13	TO252 (Standard)	B6

Package Outline Dimensions

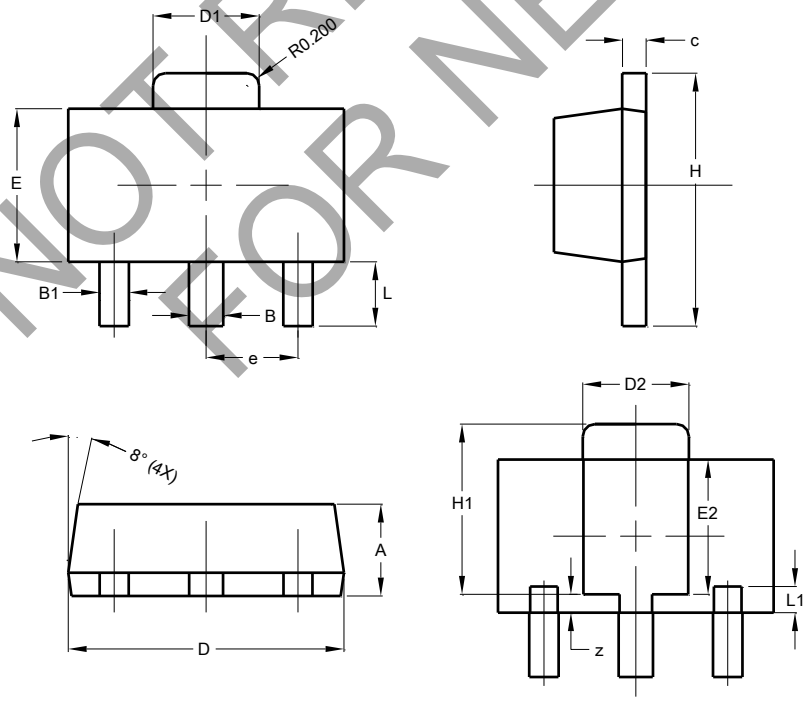
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) PowerDI123 (Type B)



PowerDI123 (Type B)			
Dim	Min	Max	Typ
A	3.50	3.90	3.70
B	2.60	3.00	2.80
C	1.63	1.93	1.78
D	0.93	1.00	0.98
E	0.85	1.25	1.00
H	0.15	0.25	0.20
L	0.50	0.80	0.65
All Dimensions in mm			

(2) SOT89

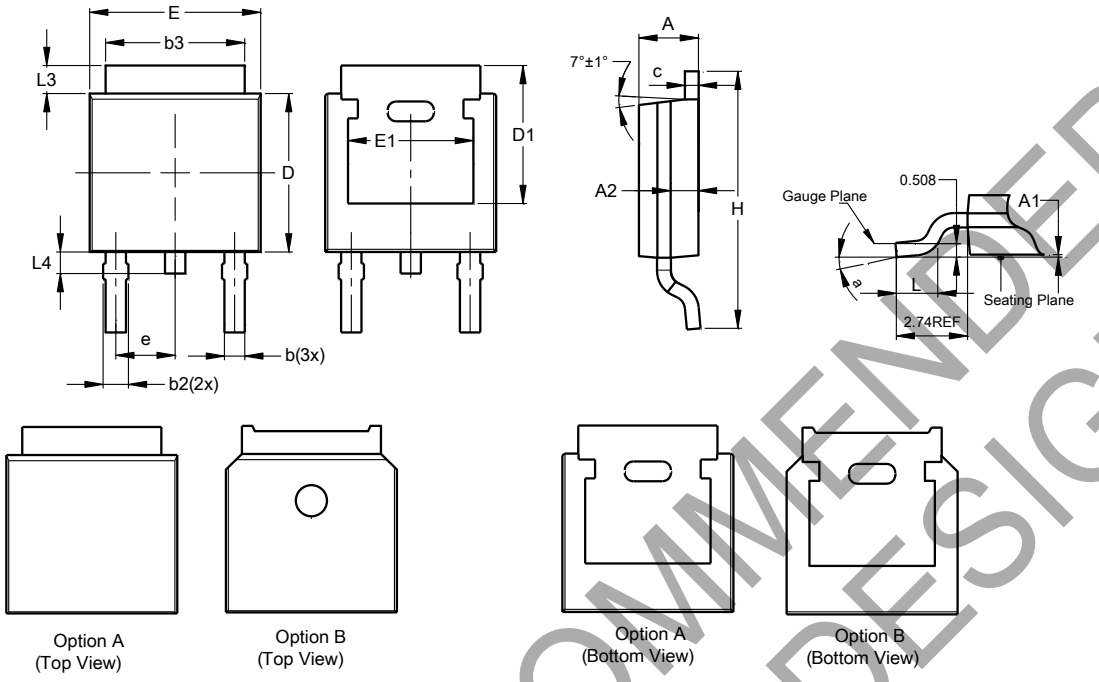


SOT89			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
B	0.50	0.62	0.56
B1	0.42	0.54	0.48
c	0.35	0.43	0.38
D	4.40	4.60	4.50
D1	1.62	1.83	1.733
D2	1.61	1.81	1.71
E	2.40	2.60	2.50
E2	2.05	2.35	2.20
e	-	-	1.50
H	3.95	4.25	4.10
H1	2.63	2.93	2.78
L	0.90	1.20	1.05
L1	0.327	0.527	0.427
z	0.20	0.40	0.30
All Dimensions in mm			

Package Outline Dimensions (Cont.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) TO252 (Standard)

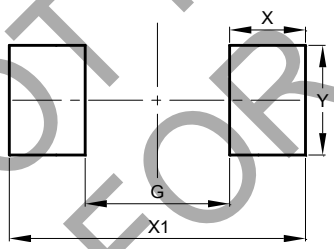


TO252 (Standard)			
Dim	**Min**	**Max**	**Typ**
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	-	-
e	-	-	2.286
E	6.45	6.70	6.58
E1	4.32	-	-
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.60	1.02	0.83
a	0°	10°	-
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) PowerDI123 (Type B)

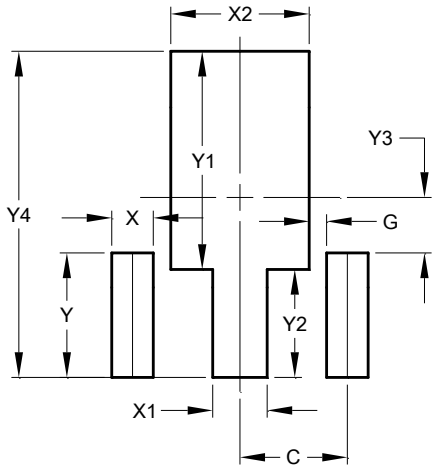


Dimensions	Value (in mm)
G	2.000
X	1.050
X1	4.100
Y	1.500

Suggested Pad Layout (Cont.)

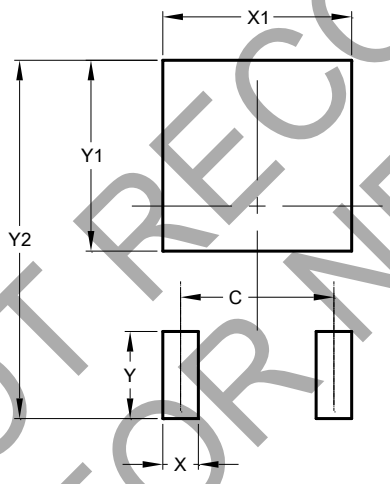
Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) SOT89



Dimensions	Value (in mm)
C	1.500
G	0.244
X	0.580
X1	0.760
X2	1.933
Y	1.730
Y1	3.030
Y2	1.500
Y3	0.770
Y4	4.530

(3) TO252 (Standard)

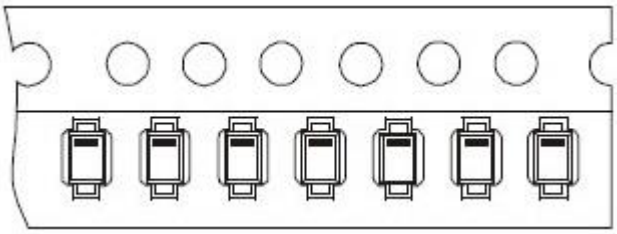


Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

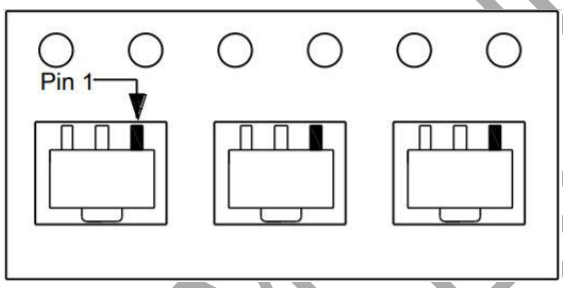
Taping Orientation

The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf.

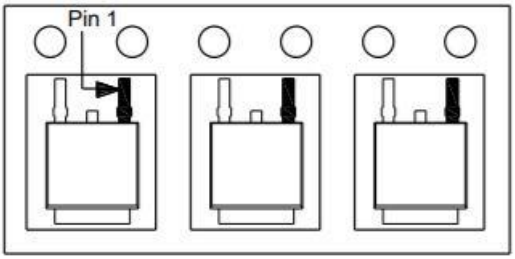
PowerDI123 (Type B)

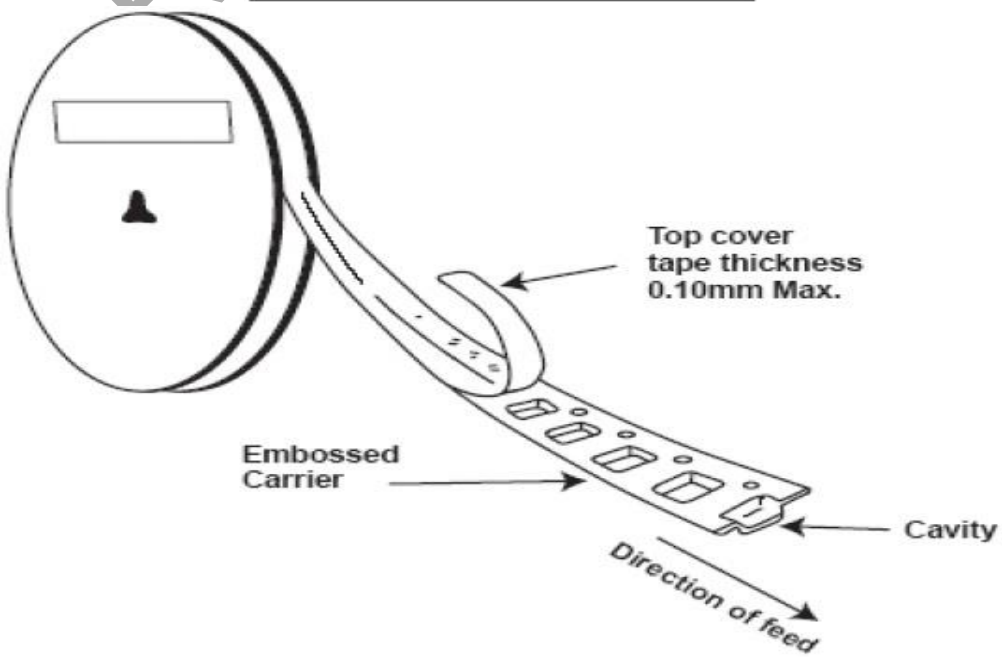


SOT89



TO252 (Standard)





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